

Atomic-Layer Deposited Nb_2O_5 : A Novel Passivating Contact Material?

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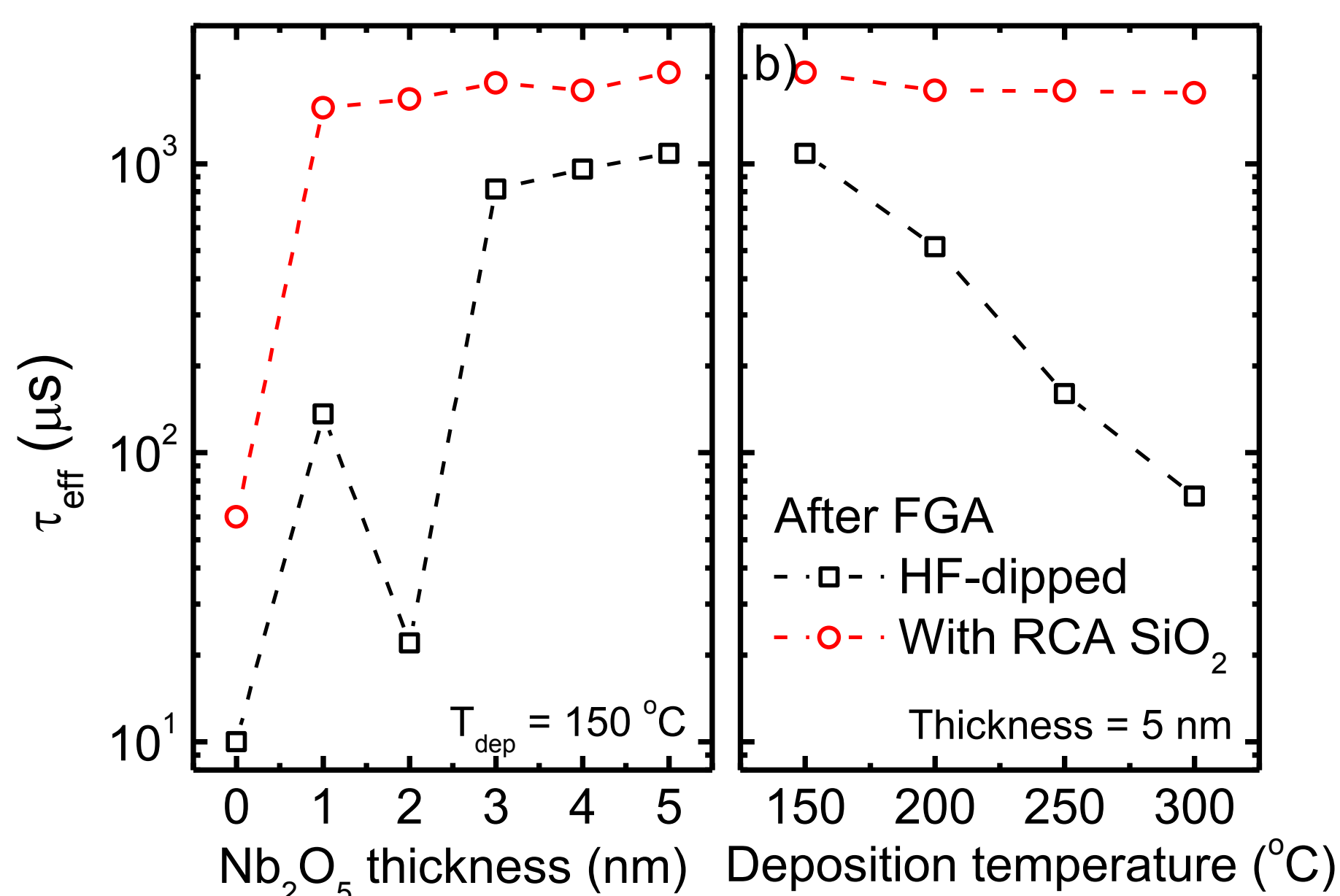
The idea: ALD Nb_2O_5 as e-selective contact:

- Should have similar band offsets as TiO_2
- More thermally stable?

Used n-type FZ wafers as substrate, either:

- HF dipped prior to ALD Nb_2O_5
- With RCA-grown SiO_2

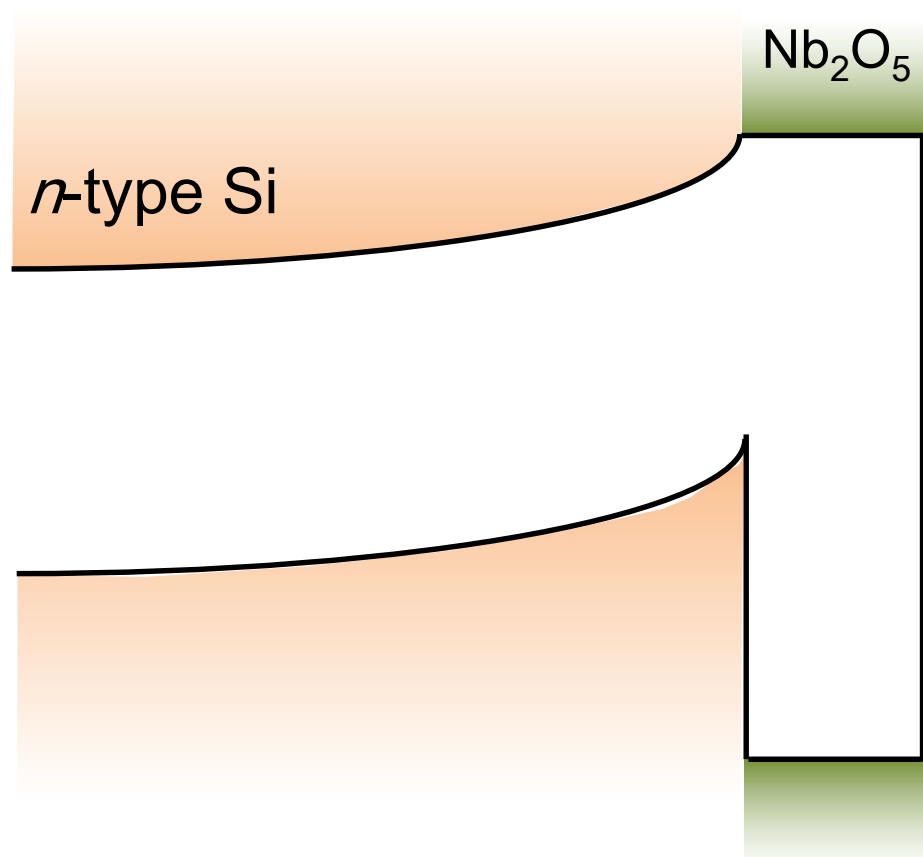
Passivation results:



Good passivation on both surfaces, but for RCA:

- Better passivation
- Lower sensitivity to T_{dep} and thickness
- Good passivation for only 1 nm!

Field-effect passivation:

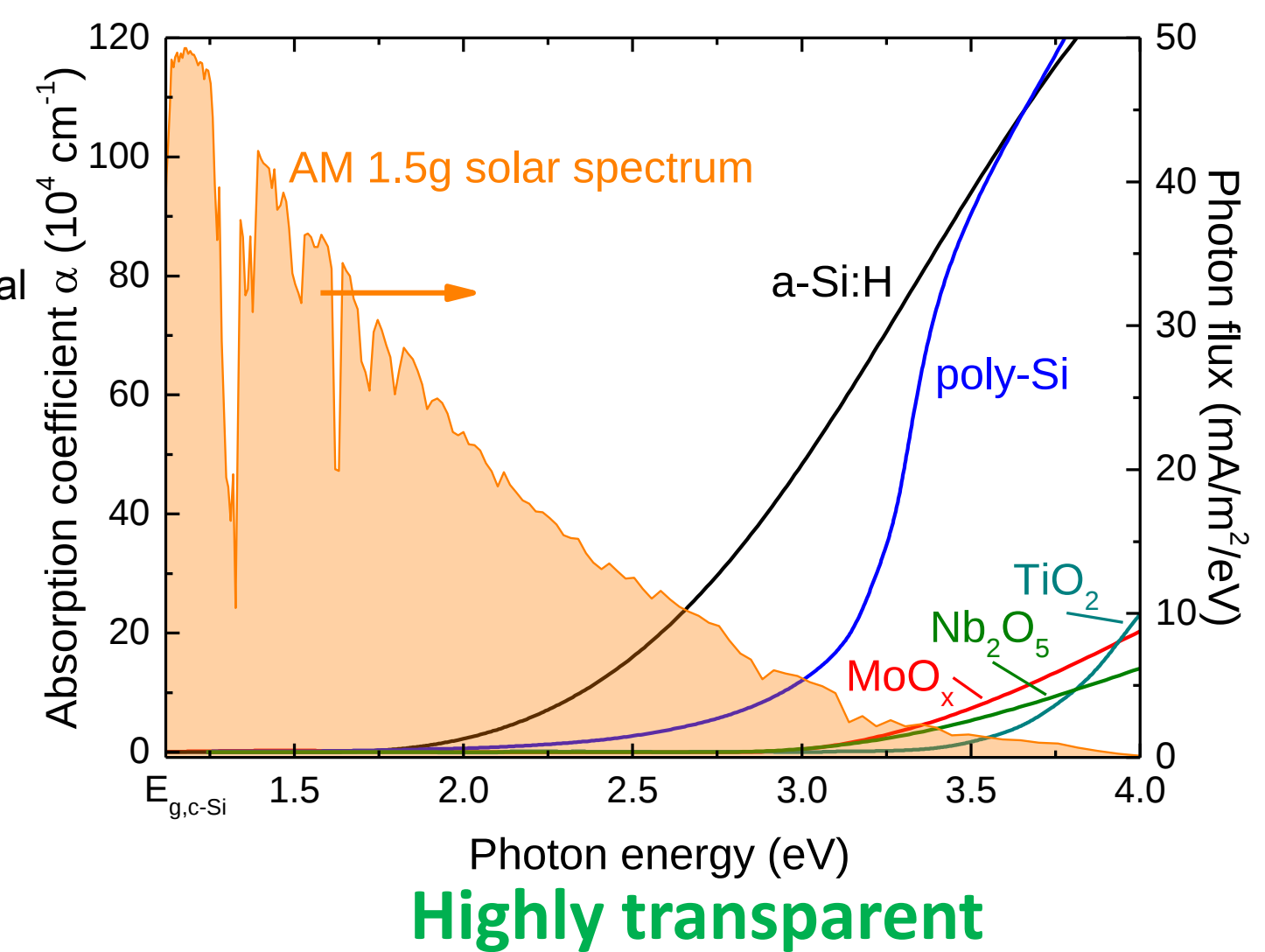
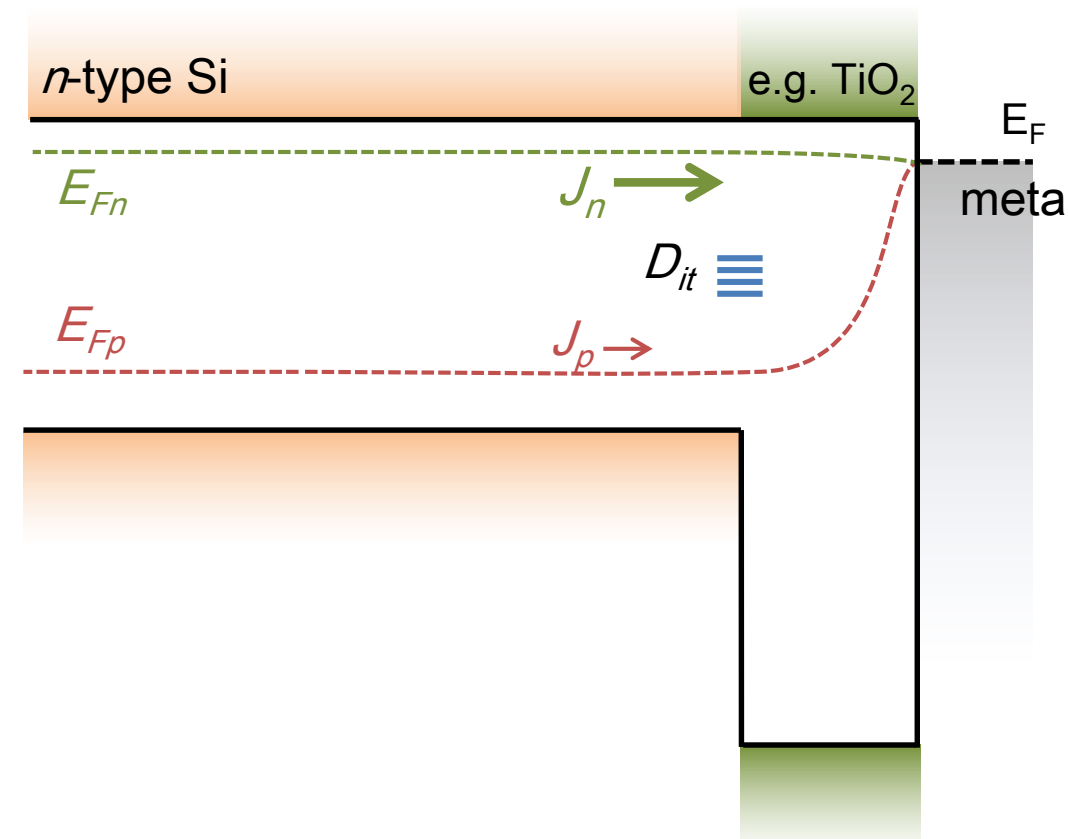


SPV measurements:

- ~ 850 mV upward on both HF/RCA
- This would imply hole-selectivity!
- Although this is also observed for TiO_2 $\rightarrow$ influence metal?

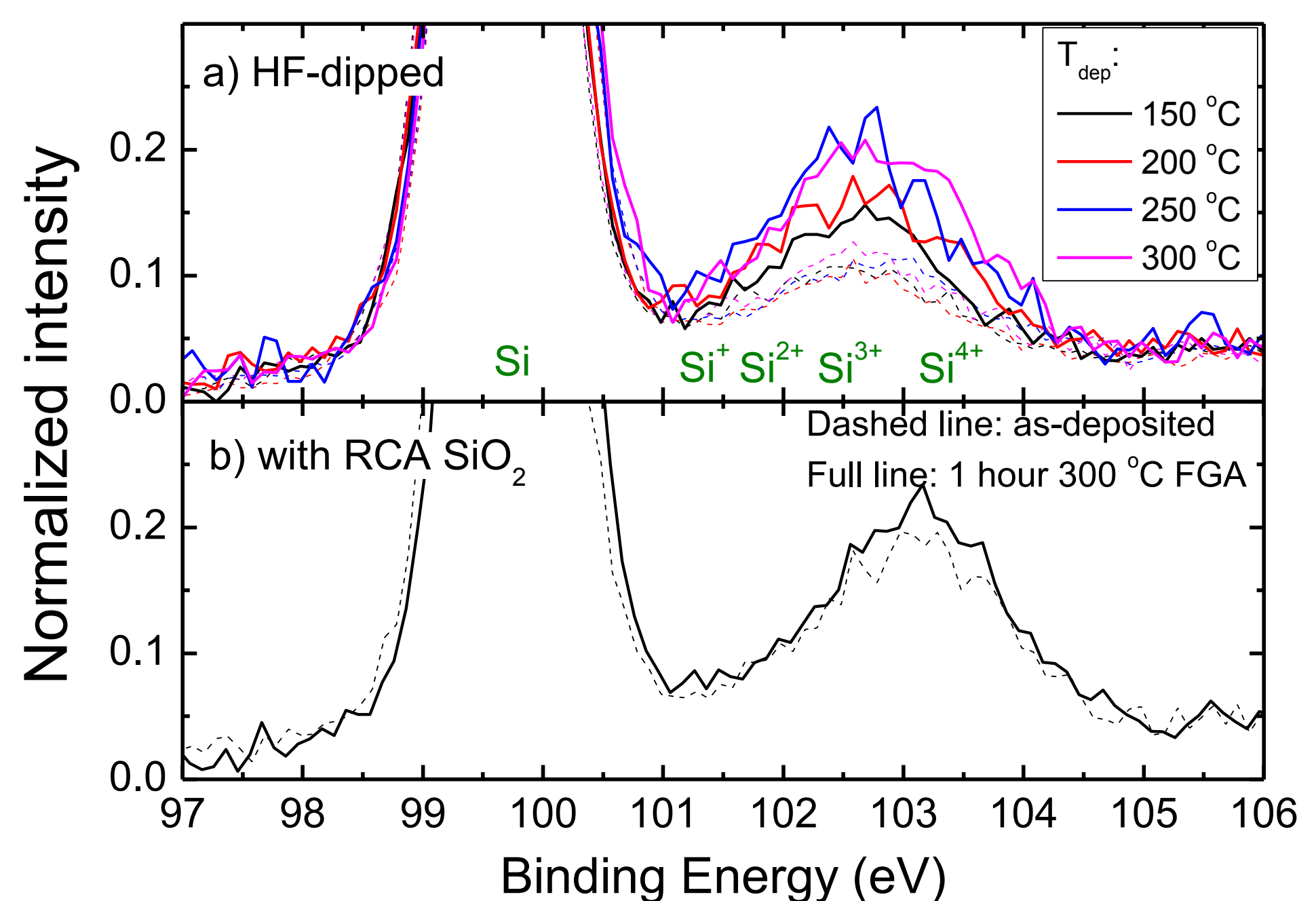
Conclusions:

- ALD Nb_2O_5 enables good passivation (champion J_0 13 fA/cm^2)
- Presence of RCA oxide improves passivation and enables use of thinner Nb_2O_5
- Even though Nb_2O_5 induces a very strong upward band bending, a good n-type contact can be formed!
- **Next steps:** Check selectivity: J_0 after metal? + solar cell implementation!



Chemical passivation:

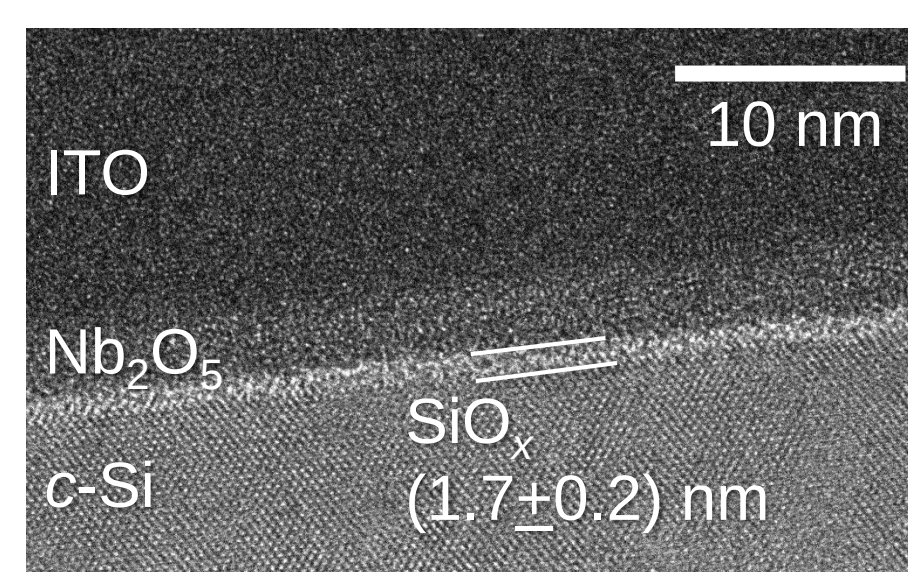
Investigated oxidation state of interfacial oxide by XPS



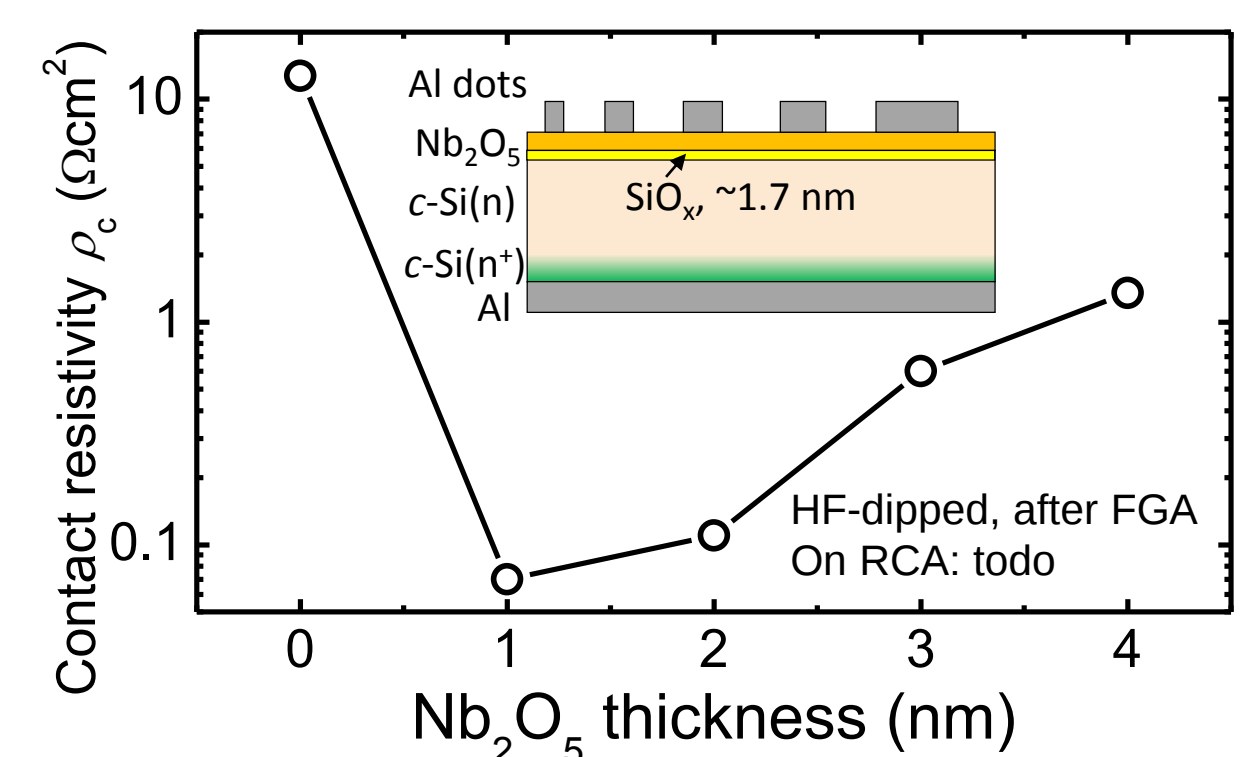
On HF-dipped: Oxide grows upon FGA, depends on T_{dep}

On RCA SiO_2 : Oxide is more stoichiometric and independent of T_{dep} and annealing

TEM and contact resistance:



HF-dipped, after FGA



Good ρ_c on n-type structure!

Al contact negates upward band bending?